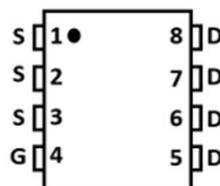
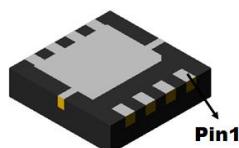
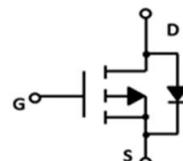


**P-Channel Enhancement Mode Field Effect Transistor****DFN3.3X3.3****Product Summary**

- V_{DS} -30V
- I_D -50A
- $R_{DS(ON)}$ (at $V_{GS}=-10V$) <6.2mohm
- $R_{DS(ON)}$ (at $V_{GS}=-4.5V$) <11mohm
- 100% ∇V_{DS} Tested

General Description

- Trench Power LV MOSFET technology
- High Power and current handing capability

Applications

- High current load applications
- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

■ Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		V_{DS}	-30	V
Gate-source Voltage		V_{GS}	± 25	V
Drain Current	$T_c=25^\circ\text{C}$	I_D	-50	A
	$T_c=70^\circ\text{C}$		-40	
Pulsed Drain Current ^A		I_{DM}	-200	A
Total Power Dissipation	$T_c=25^\circ\text{C}$	P_D	83	W
	$T_A=25^\circ\text{C}$		5.2	
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+150	°C

■ Thermal resistance

Parameter		Symbol	Typ	Max	Units
Junction to Ambient @Maximum ^B	$t \leq 10\text{s}$	$R_{\theta JA}$	18	24	°C/W
Junction to Ambient @Maximum ^{BC}	Steady-State		36	50	
Junction to Case @Maximum	Steady-State		1	1.5	

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJQ50P03A	F1	Q50P03A	5000	10000	100000	13" reel



YJQ50P03A

■ Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}$			-1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{\text{GS}}= \pm 25\text{V}, V_{\text{DS}}=0\text{V}$			± 100	nA
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}= V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	-1.2	-1.8	-2.8	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}= -10\text{V}, I_{\text{D}}= -15\text{A}$		5.0	6.2	$\text{m}\Omega$
		$V_{\text{GS}}= -4.5\text{V}, I_{\text{D}}= -10\text{A}$		6.9	11	
Diode Forward Voltage	V_{SD}	$I_{\text{S}}= -15\text{A}, V_{\text{GS}}=0\text{V}$			-1.2	V
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{\text{DS}}=-15\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$		6464		pF
Output Capacitance	C_{oss}			779		
Reverse Transfer Capacitance	C_{rss}			477		
Switching Parameters						
Total Gate Charge	Q_g	$V_{\text{GS}}= -10\text{V}, V_{\text{DS}}= -15\text{V}, I_{\text{D}}= -20\text{A}$		111.7		nC
Gate-Source Charge	Q_{gs}			21.1		
Gate-Drain Charge	Q_{gd}			22.9		
Reverse Recovery Charge	Q_{rr}	$I_{\text{F}}=-20\text{A}, dI/dt=100\text{A}/\mu\text{s}$		8.5		ns
Reverse Recovery Time	t_{rr}			24		
Turn-on Delay Time	$t_{\text{D}(\text{on})}$	$V_{\text{GS}}= -10\text{V}, V_{\text{DD}}= -15\text{V}, R_{\text{G}}=3\Omega, R_{\text{L}}= 0.75\Omega$		15		
Turn-on Rise Time	t_r			79		
Turn-off Delay Time	$t_{\text{D}(\text{off})}$			136		
Turn-off fall Time	t_f			80		

A: Pulse Test: Pulse Width≤300μs, Duty cycle≤2%.

B. The value of $R_{\theta_{\text{JA}}}$ is measured with the device mounted on 1 in² FR-4 board with 2oz,Copper,in a still air.environment with $T_A = 25^\circ\text{C}$,The Value in any given application depends on the user's specific board design.

C. The $R_{\theta_{\text{JC}}}$ is the sum of the thermal impedance from junction to lead $R_{\theta_{\text{JC}}}$ and lead to ambient.

■ Typical Performance Characteristics

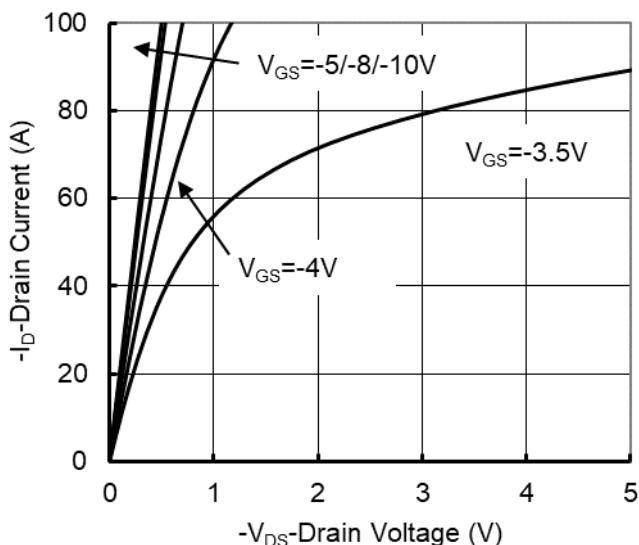


Figure 1. Output Characteristics

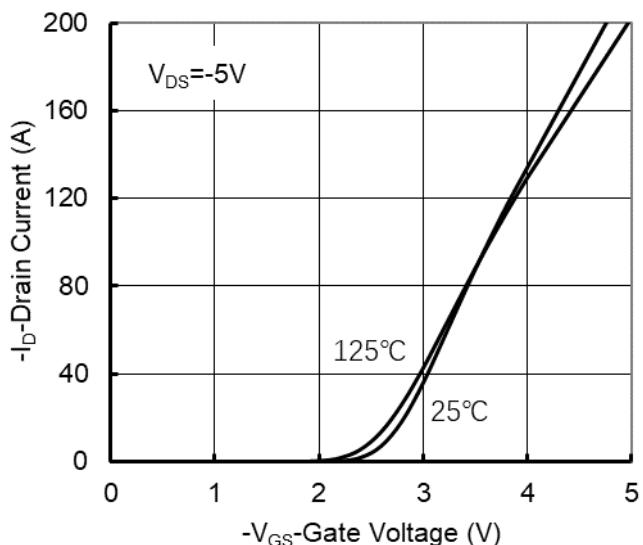


Figure 2. Transfer Characteristics

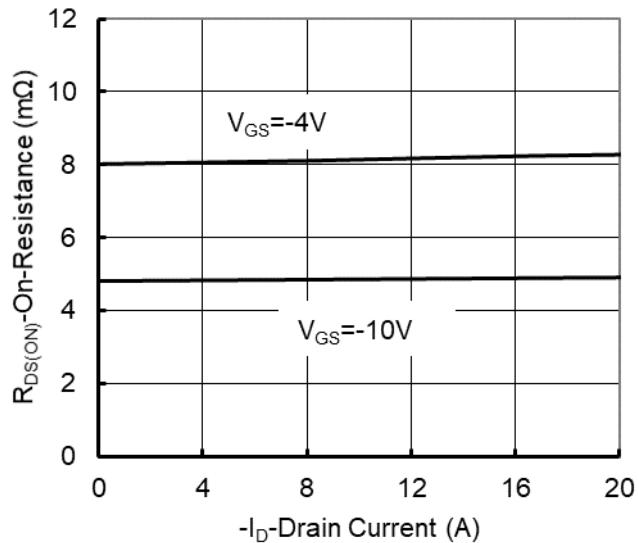


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

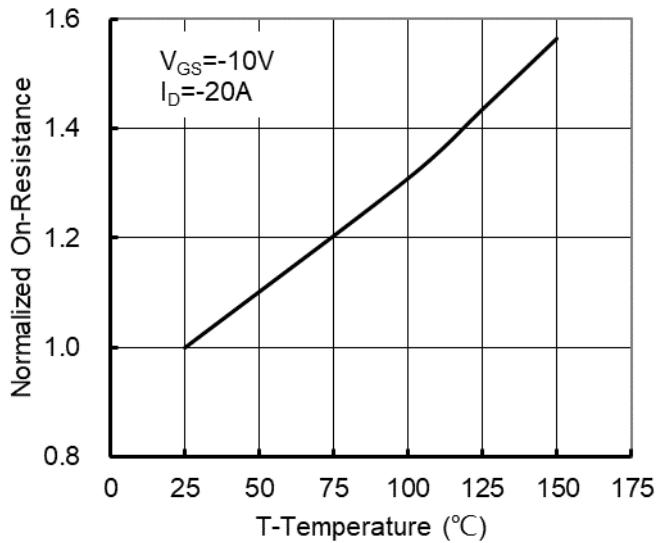


Figure 4: On-Resistance vs. Junction Temperature

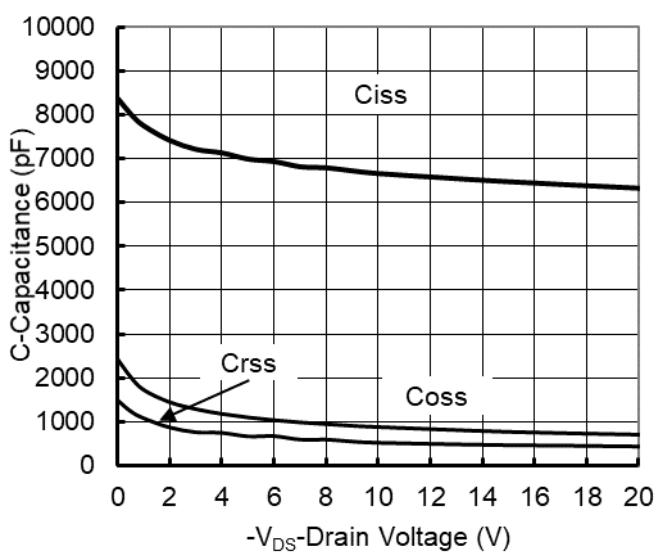


Figure 5. Capacitance Characteristics

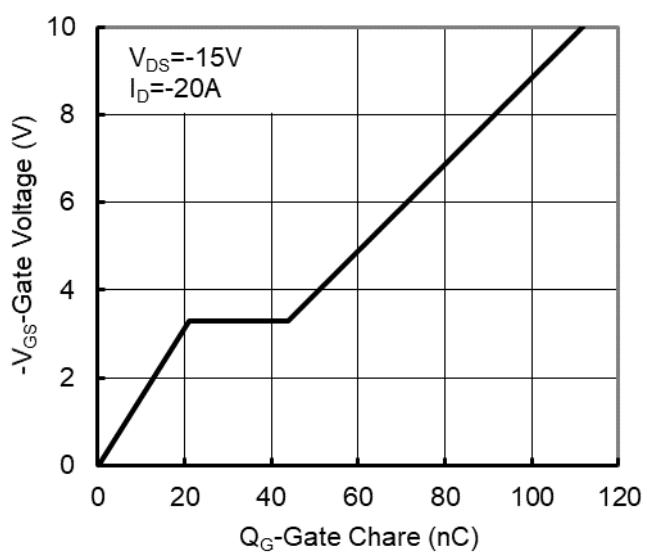
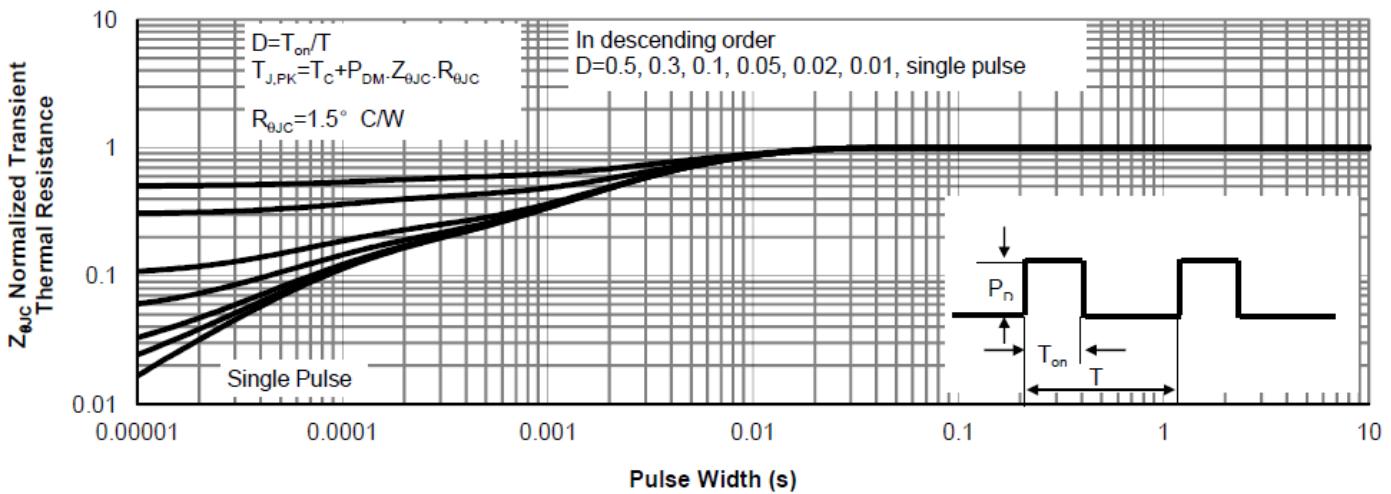
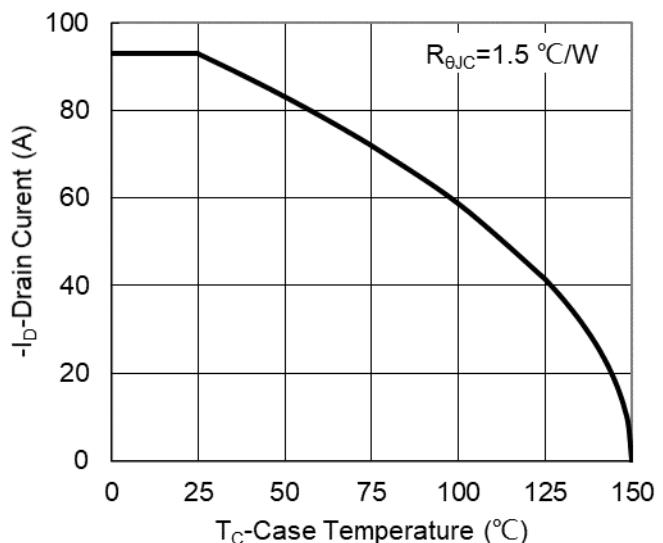
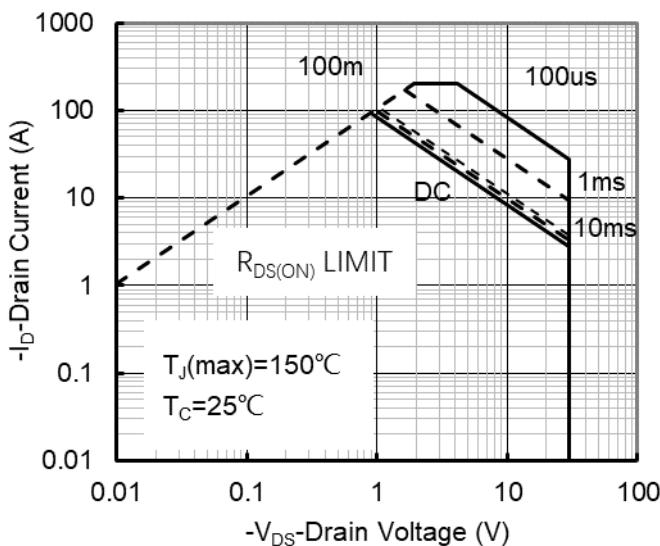
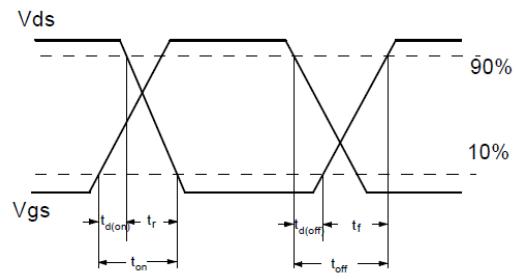
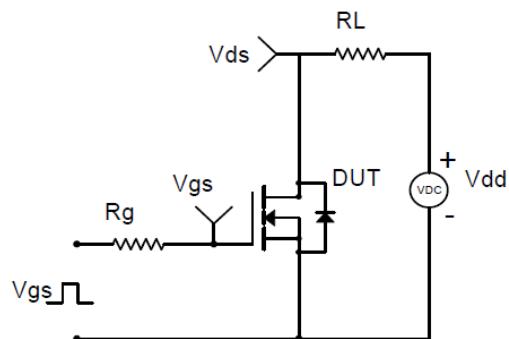
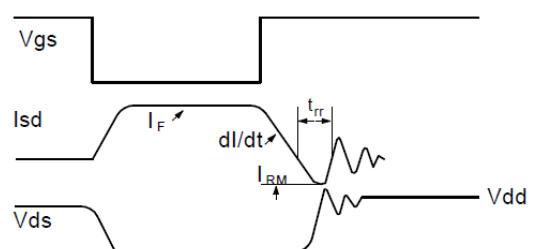
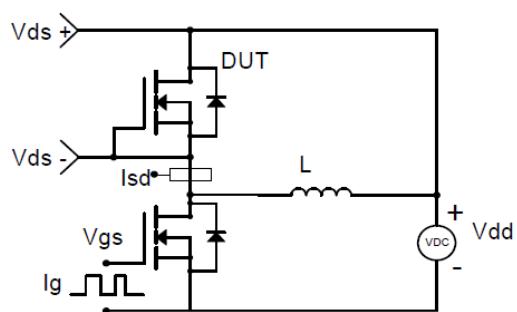


Figure 6. Gate Charge

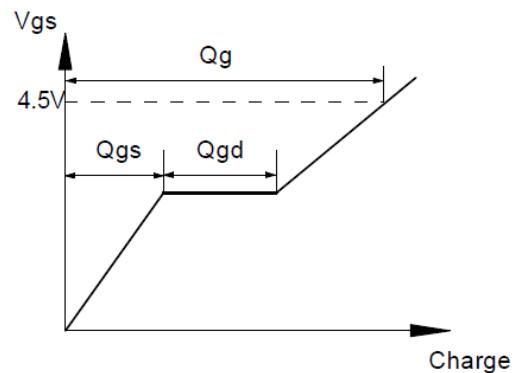
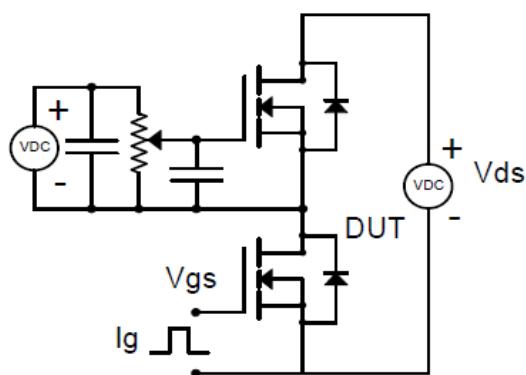




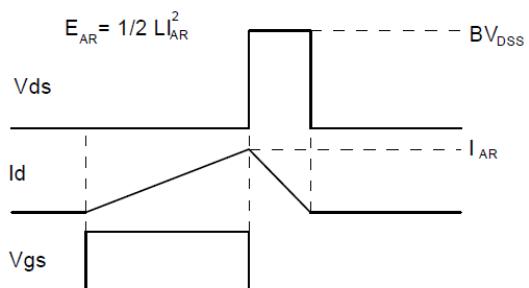
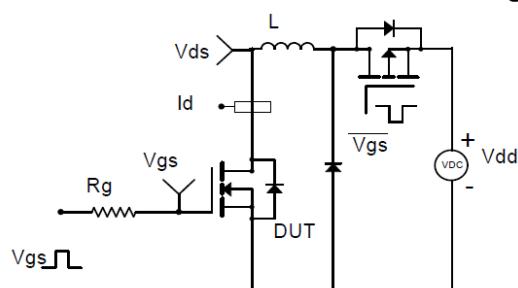
Resistive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



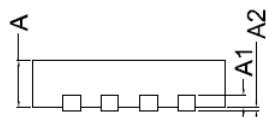
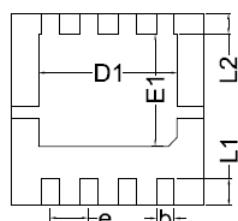
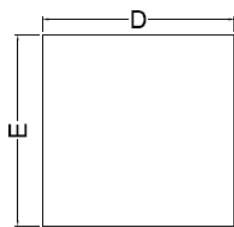
Gate Charge Test Circuit & Waveform



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



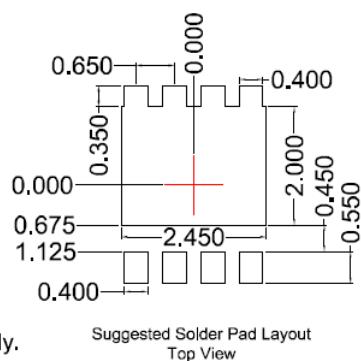
■ DFN3.3×3.3 Package information

Top View
正面视图Bottom View
背面视图Side View
侧面视图

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	3.15	3.25	3.35
E	3.15	3.25	3.35
A	0.70	0.80	0.90
A1	0.20 BSC		
A2			0.10
D1	2.20	2.35	2.50
E1	1.80	1.90	2.00
L1	0.35	0.45	0.55
L2	0.35 BSC		
b	0.20	0.30	0.40
e	0.65 BSC		

Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.10\text{mm}$.
3. The pad layout is for reference purposes only.





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